

Fig. 2

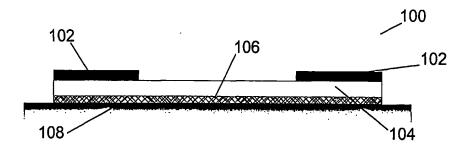
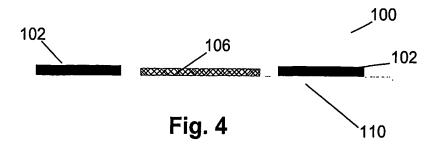


Fig. 3



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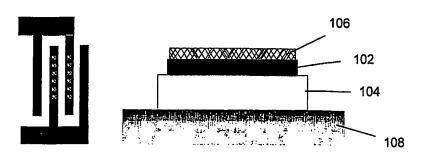


Fig. 5

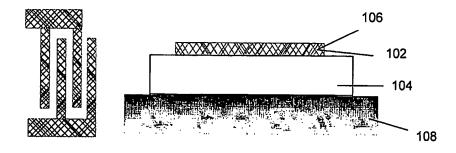


Fig. 6



Fig. 7

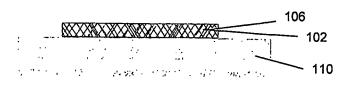


Fig. 8

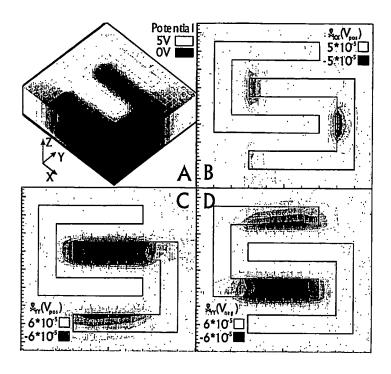


Fig. 9

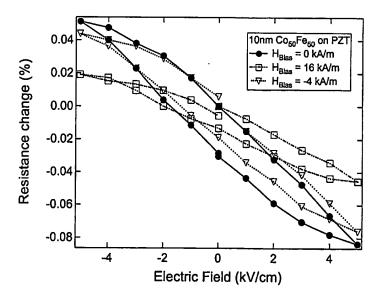


Fig. 10

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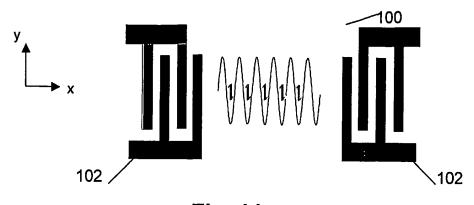


Fig. 11a

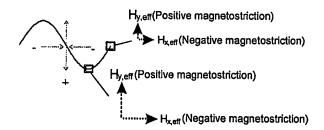
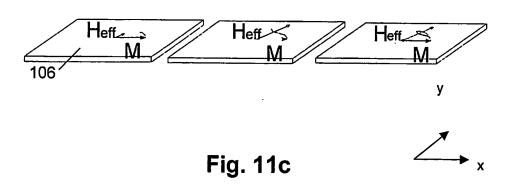


Fig. 11b



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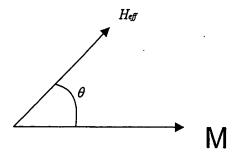
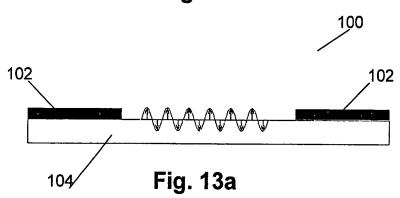


Fig. 12



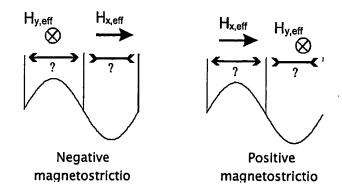
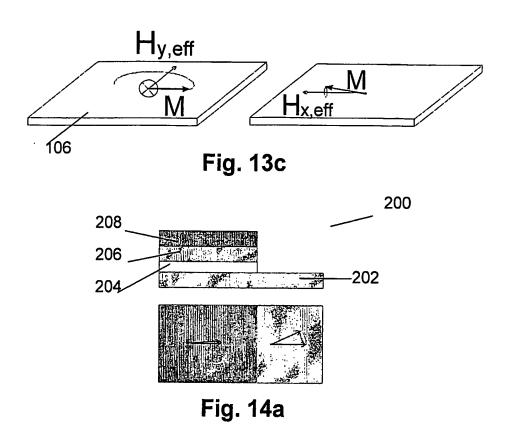


Fig. 13b

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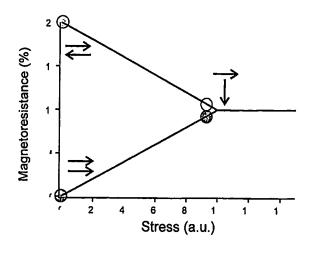


Fig. 14b

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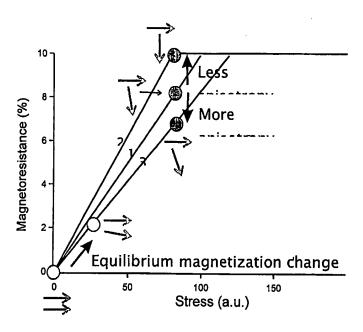


Fig. 14c

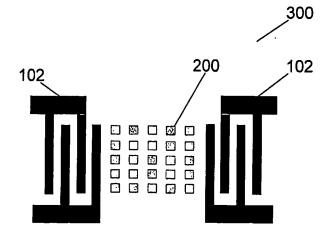


Fig. 15a

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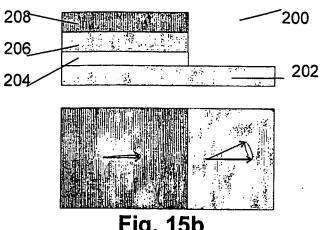


Fig. 15b

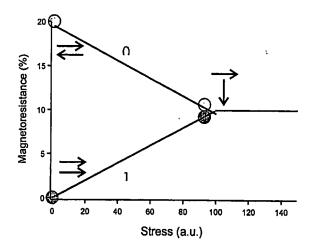


Fig. 15c

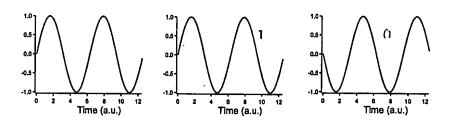


Fig. 15d

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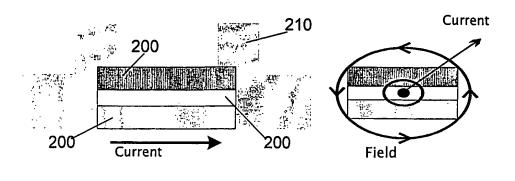


Fig. 16

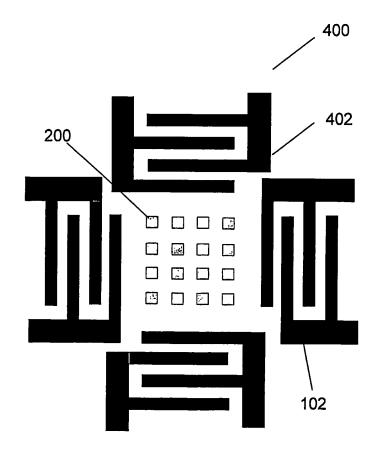


Fig. 17

PCT/EP2004/014815

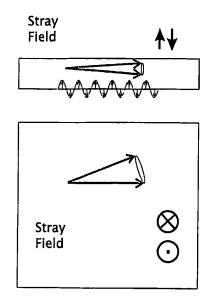
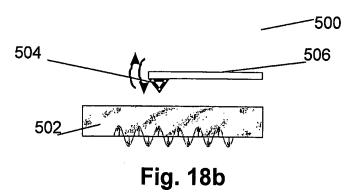


Fig. 18a



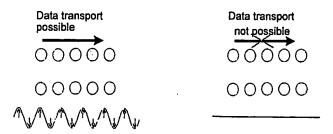


Fig. 19

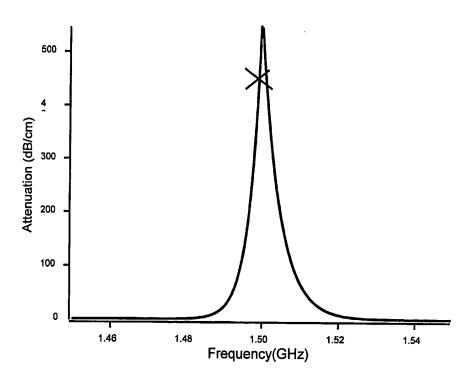


Fig. 20

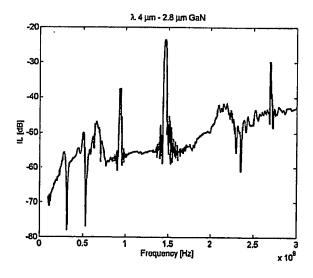
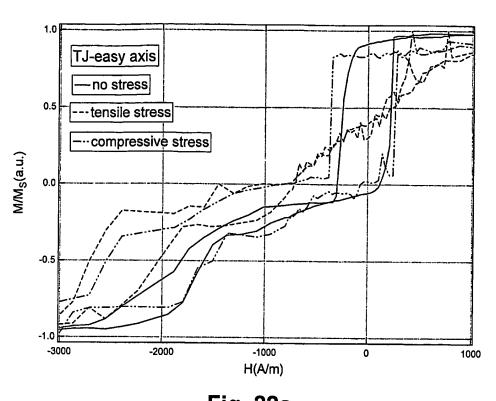
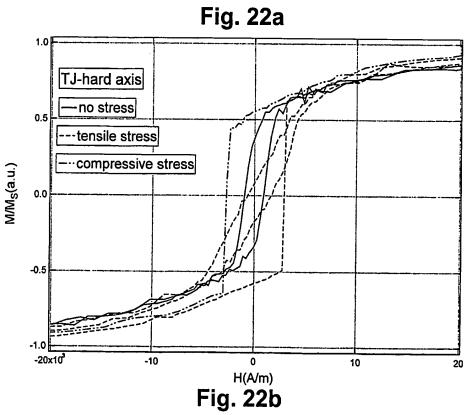


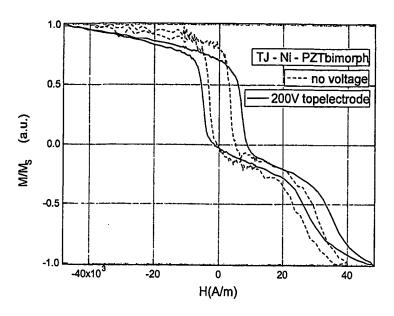
Fig.21

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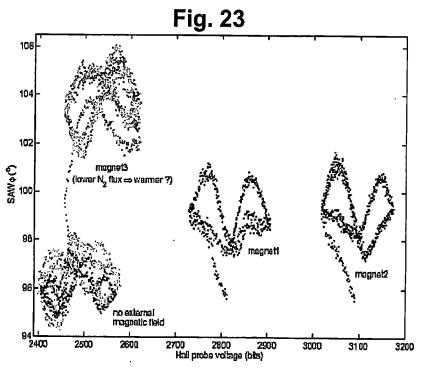


Fig. 24

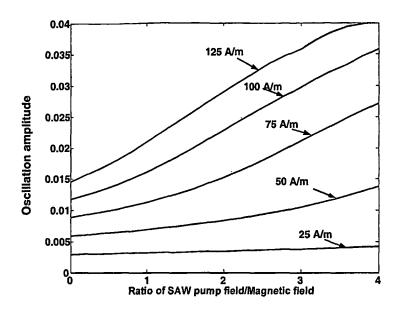


Fig. 25

